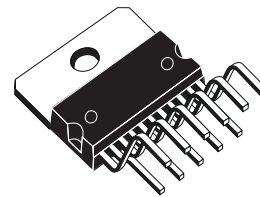




## TDA2009A

### 10 + 10W STEREO AMPLIFIER

- HIGH OUTPUT POWER  
(10 + 10W Min. @ D = 1%)
- HIGH CURRENT CAPABILITY (UP TO 3.5A)
- AC SHORT CIRCUIT PROTECTION
- THERMAL OVERLOAD PROTECTION
- SPACE AND COST SAVING : VERY LOW  
NUMBER OF EXTERNAL COMPONENTS  
AND SIMPLE MOUNTING THANKS TO THE  
MULTIWATT® PACKAGE.



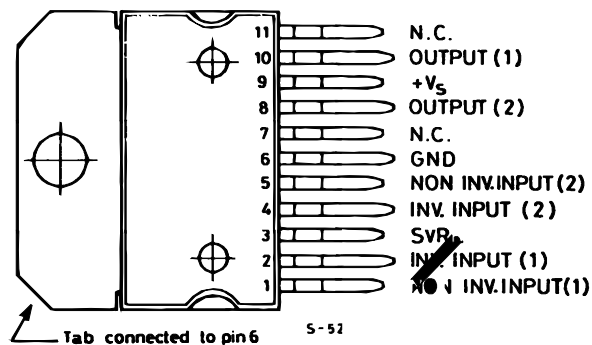
MULTIWATT11

ORDERING NUMBER : TDA2009A

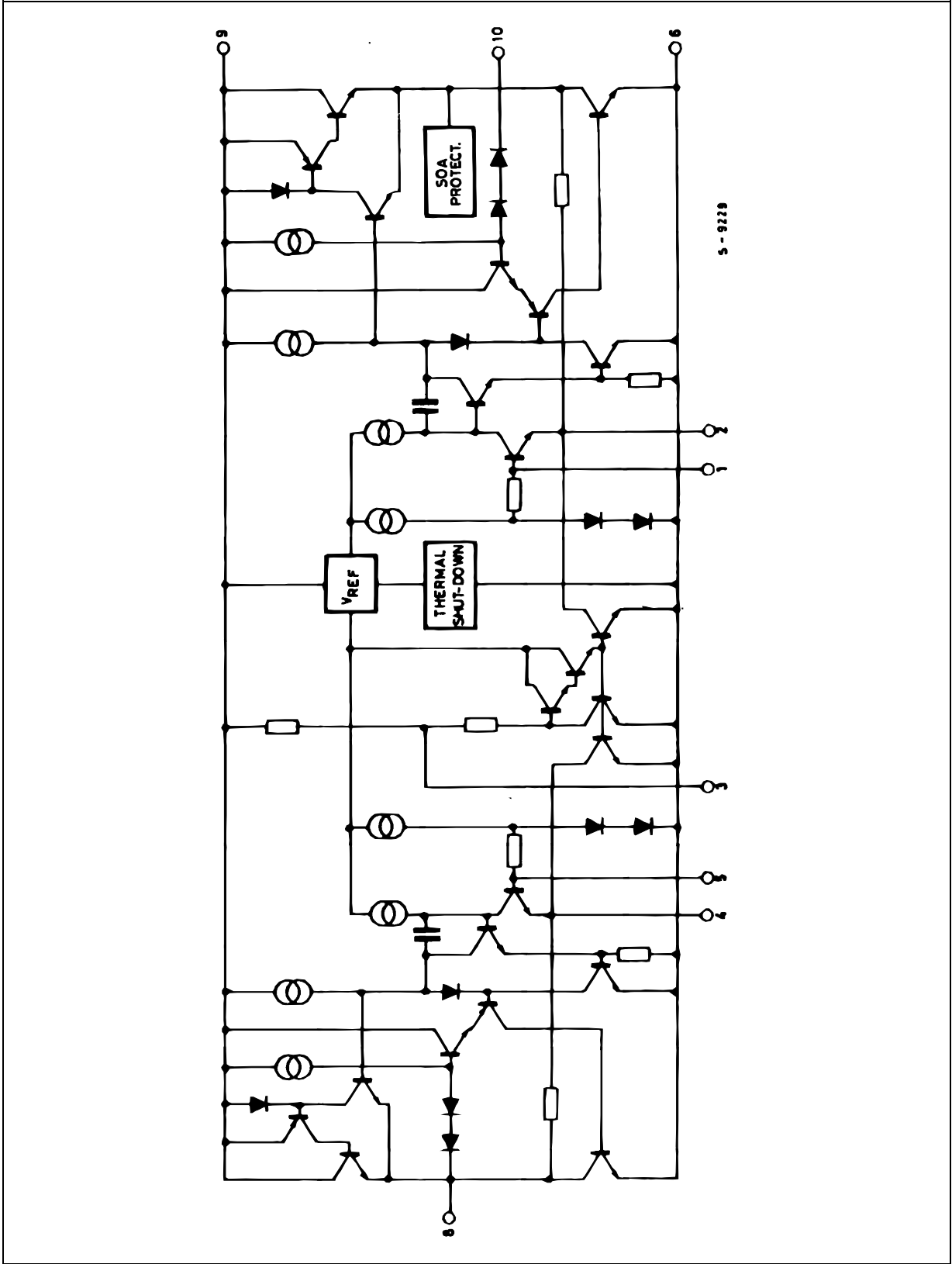
#### DESCRIPTION

The TDA2009A is class AB dual Hi-Fi Audio power amplifier assembled in Multiwatt® package, specially designed for high quality stereo application as Hi-Fi and music centers.

#### PIN CONNECTION



SCHEMATIC DIAGRAM



**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_s$	Supply Voltage	28	V
$I_o$	Output Peak Current (repetitive $f \geq 20$ Hz)	3.5	A
$I_o$	Output Peak Current (non repetitive, $t = 100 \mu s$ )	4.5	A
$P_{tot}$	Power Dissipation at $T_{case} = 90^\circ C$	20	W
$T_{stg}, T_j$	Storage and Junction Temperature	- 40, + 150	$^\circ C$

**THERMAL DATA**

Symbol	Parameter	Value	Unit
$R_{th j-case}$	Thermal Resistance Junction-case Max.	3	$^\circ C/W$

**ELECTRICAL CHARACTERISTICS**

(refer to the stereo application circuit,  $T_{amb} = 25^\circ C$ ,  $V_s = 24V$ ,  $G_v = 36dB$ , unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_s$	Supply Voltage		8		28	V
$V_o$	Quiescent Output Voltage	$V_s = 24V$		11.5		V
$I_d$	Total Quiescent Drain Current	$V_s = 24V$		60	120	mA
$P_o$	Output Power (each channel)	$d = 1\%, V_s = 24V, f = 1kHz$ $R_L = 4\Omega$ $R_L = 8\Omega$ $f = 40Hz$ to $12.5kHz$ $R_L = 4\Omega$ $R_L = 8\Omega$ $V_s = 18V, f = 1kHz$ $R_L = 4\Omega$ $R_L = 8\Omega$	10 5	12.5 7		W W W W W W
$d$	Distortion (each channel)	$f = 1kHz, V_s = 24V$ $P_o = 0.1$ to $7W$ $R_L = 4\Omega$ $P_o = 0.1$ to $3.5W$ $R_L = 8\Omega$ $V_s = 18V$ $P_o = 0.1$ to $5W$ $R_L = 4\Omega$ $P_o = 0.1$ to $2.5W$ $R_L = 8\Omega$		0.2 0.1 0.2 0.1		% % % %
CT	Cross Talk (3)	$R_L = \infty, R_g = 10k\Omega$ $f = 1kHz$ $f = 10kHz$		60 50		dB
$V_i$	Input Saturation Voltage (rms)		300			mV
$R_i$	Input Resistance	$f = 1kHz$ , Non Inverting Input	70	200		$k\Omega$
$f_L$	Low Frequency Roll off (– 3dB)	$R_L = 4\Omega$		20		Hz
$f_H$	High Frequency Roll off (– 3dB)	$R_L = 4\Omega$		80		kHz
$G_v$	Voltage Gain (closed loop)	$f = 1kHz$	35.5	36	36.5	dB
$\Delta G_v$	Closed Loop Gain Matching			0.5		dB
$e_N$	Total Input Noise Voltage	$R_g = 10k\Omega$ (1) $R_g = 10k\Omega$ (2)		1.5 2.5	8	$\mu V$ $\mu V$
SVR	Supply Voltage Rejection (each channel)	$R_g = 10k\Omega$ $f_{ripple} = 100Hz, V_{ripple} = 0.5V$		55		dB
$T_J$	Thermal Shut-down Junction Temperature			145		$^\circ C$

- Notes : 1. Curve A  
2. 22Hz to 22kHz

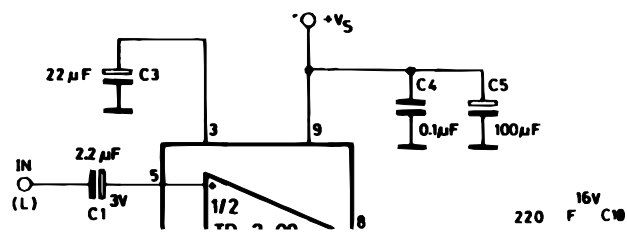


Figure 3 : Output Power versus Supply Voltage

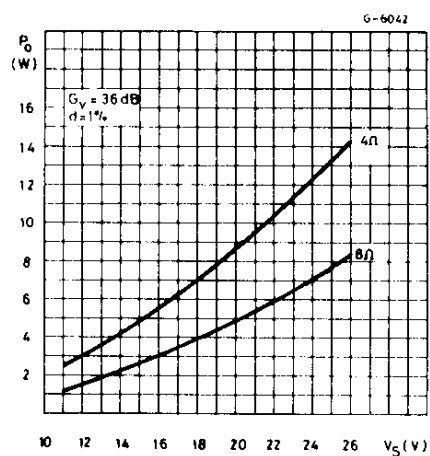


Figure 4 : Output Power versus Supply Voltage

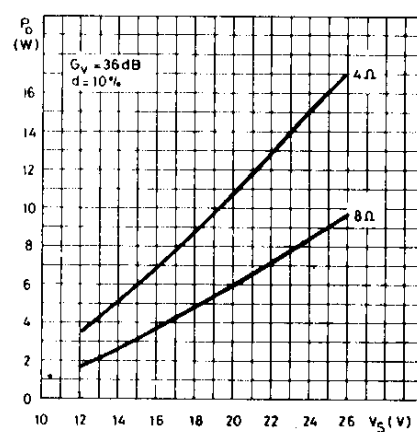


Figure 5 : Distortion versus Output Power

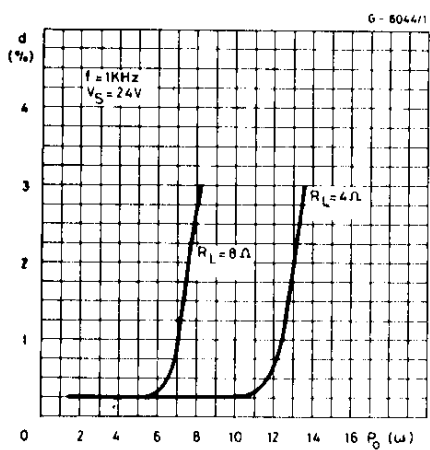


Figure 6 : Distortion versus Frequency

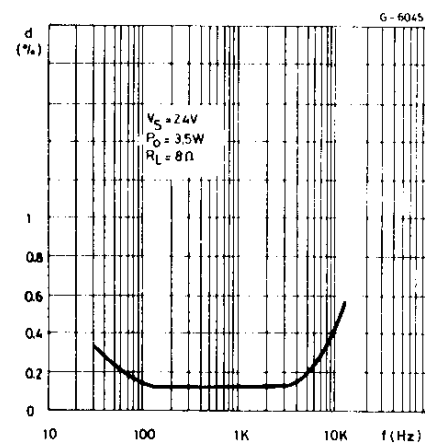


Figure 7 : Distortion versus Frequency

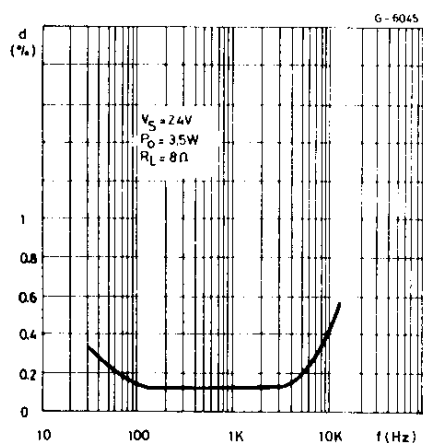


Figure 8 : Quiescent Current versus Supply Voltage

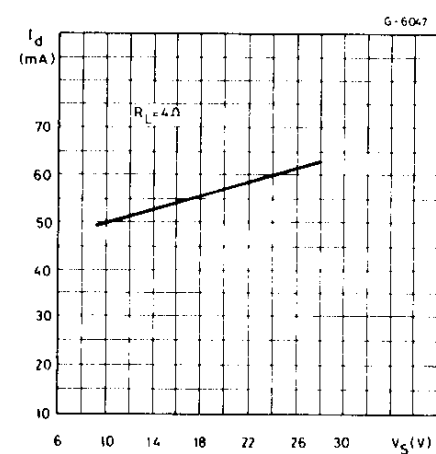


Figure 9 : Supply Voltage Rejection versus Frequency

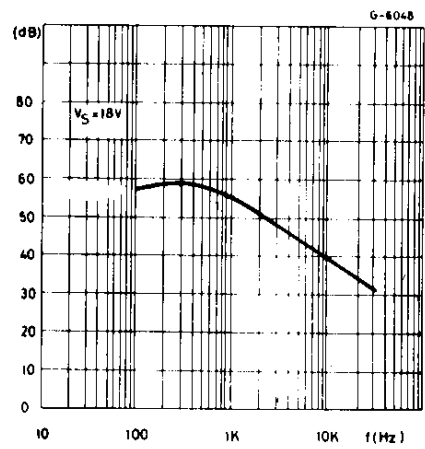


Figure 10 : Total Power Dissipation and Efficiency versus Output Power

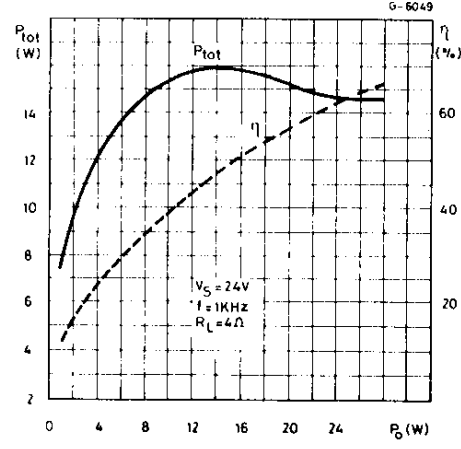
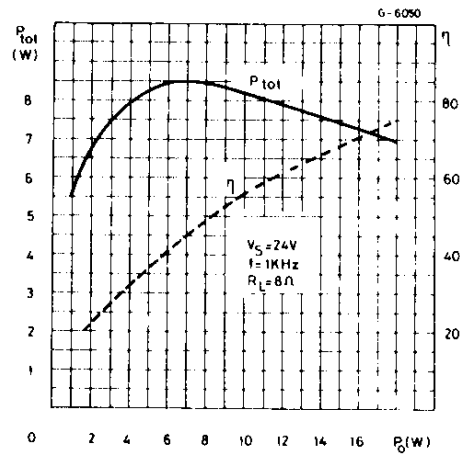


Figure 11 : Total Power Dissipation and Efficiency versus Output Power



APPLICATION INFORMATION

Figure 12 : Example of Muting Circuit

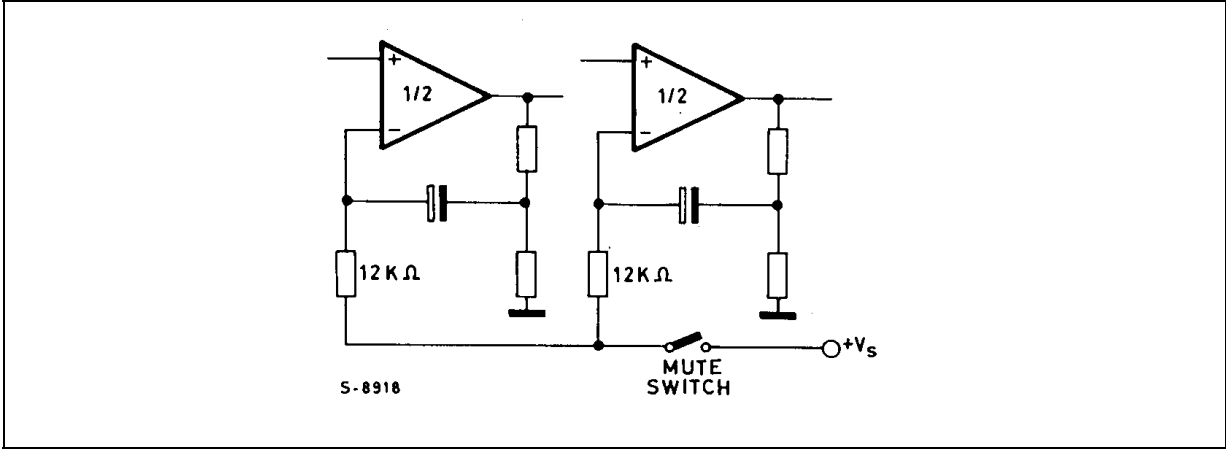
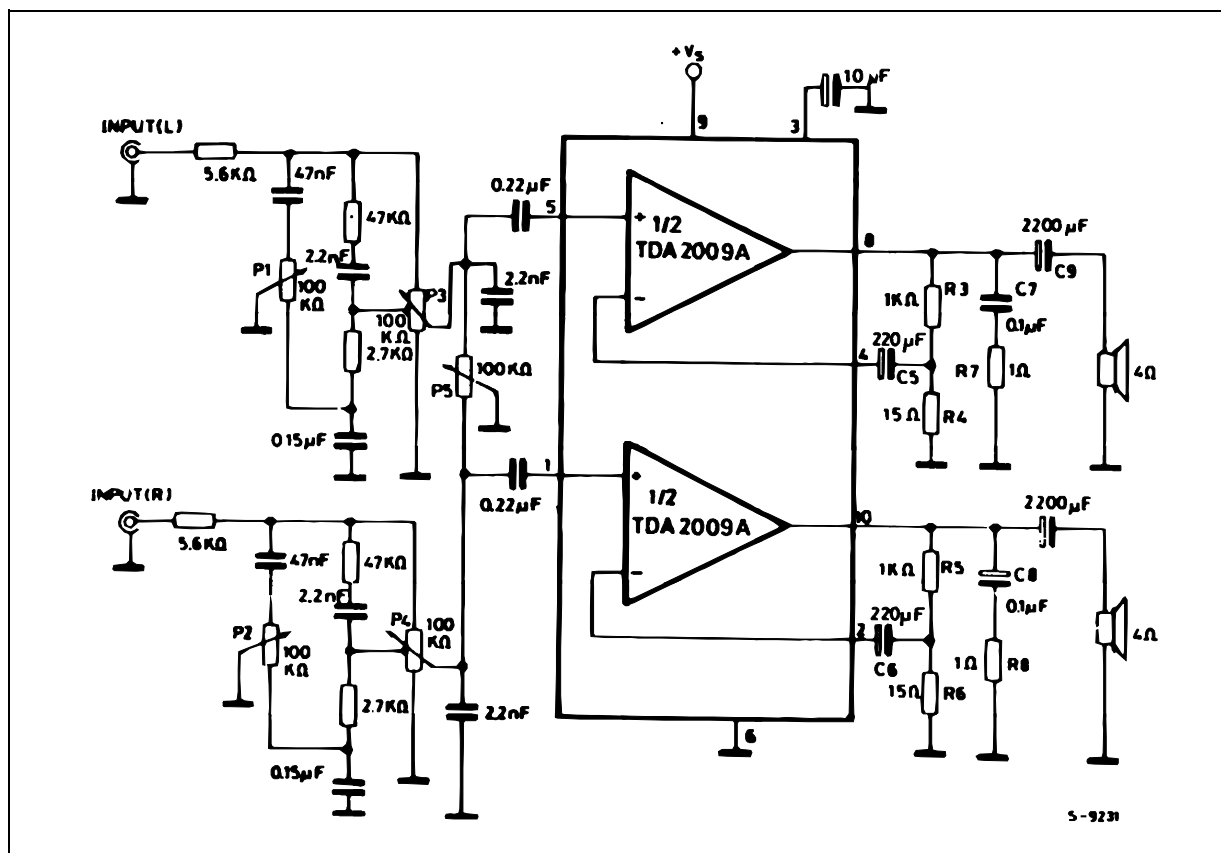
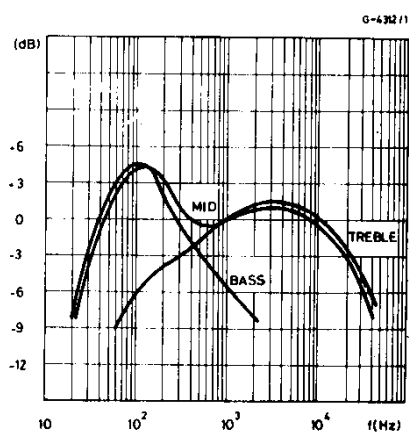
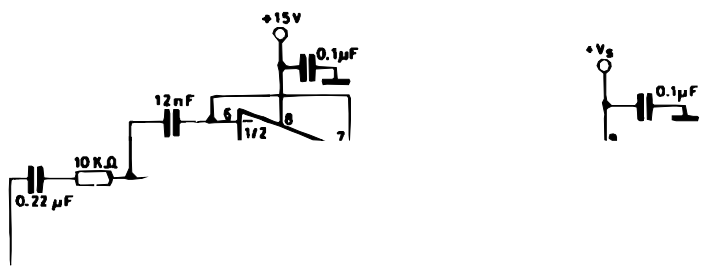
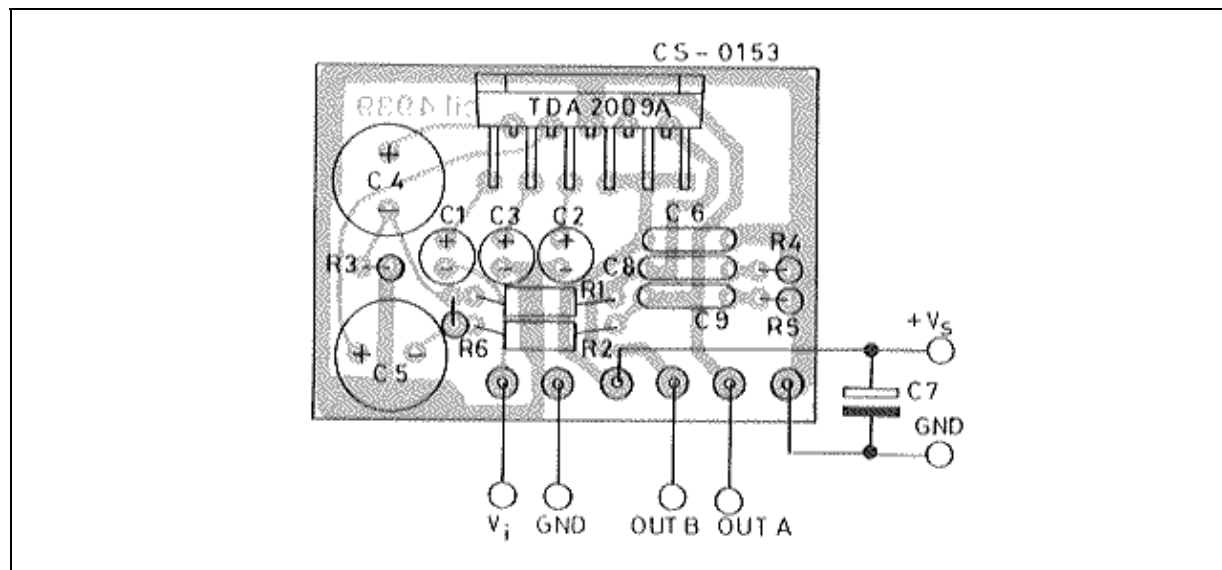


Figure 13 : 10W +10W Stereo Amplifier with Tone Balance and Loudness Control

Figure 14 : Tone Control Response  
(circuit of Figure 13)





**Figure 17** : P.C. BOARD and Components Layout of the Circuit of Figure 16 (1:1 scale)**APPLICATION SUGGESTION**

The recommended values of the components are those shown on application circuit of fig. 1. Different values can be used ; the following table can help the designer.

Component	Recommended Value	Purpose	Larger than	Smaller than
R1, R3	1.2k $\Omega$	Close Loop Gain Setting (1)	Increase of Gain	Decrease of Gain
R2, R4	18k $\Omega$		Decrease of Gain	Increase of Gain
R5, R6	1 $\Omega$	Frequency Stability	Danger of Oscillation at High Frequency with Inductive Load	
C1, C2	2.2 $\mu$ F	Input DC Decoupling	High Turn-on Delay	High Turn-on Pop. Higher Low Frequency Cut-off. Increase of Noise
C3	22 $\mu$ F	Ripple Rejection	Better SVR. Increase of the Switch-on Time	Degradation of SVR
C6, C7	220 $\mu$ F	Feedback Input DC Decoupling		
C8, C9	0.1 $\mu$ F	Frequency Stability		Danger of Oscillation
C10, C11	1000 $\mu$ F to 2200 $\mu$ F	Output DC Decoupling		Higher Low-frequency Cut-off

(1) The closed loop gain must be higher than 26dB.

**BUILD-IN PROTECTION SYSTEMS**  
**THERMAL SHUT-DOWN**

The presence of a thermal limiting circuit offers the following advantages:

- 1) an overload on the output (even if it is permanent), or an excessive ambient temperature can be easily withstood.
- 2) the heatsink can have a smaller factor of safety compared with that of a conventional circuit. There is no device damage in the case of excessive junction temperature : all that happens is that  $P_o$  (and therefore  $P_{tot}$ ) and  $I_o$  are reduced.

The maximum allowable power dissipation depends upon the size of the external heatsink (i.e. its thermal resistance); Figure 18 shows this dissippable power as a function of ambient temperature for different thermal resistance.

Short circuit (AC Conditions). The TDA2009A can withstand an accidental short circuit from the output and ground made by a wrong connection during normal play operation.

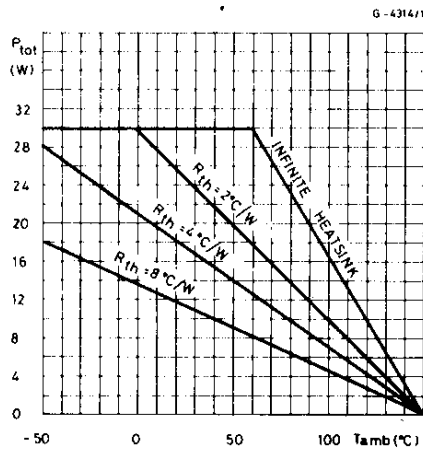
## MOUNTING INSTRUCTIONS

The power dissipated in the circuit must be removed by adding an external heatsink.

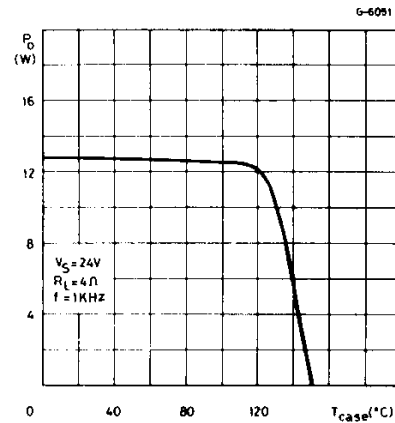
Thanks to the MULTIWATT<sup>®</sup> package attaching

the heatsink is very simple, a screw or a compression spring (clip) being sufficient. Between the heatsink and the package it is better to insert a layer of silicon grease, to optimize the thermal contact ; no electrical isolation is needed between the two

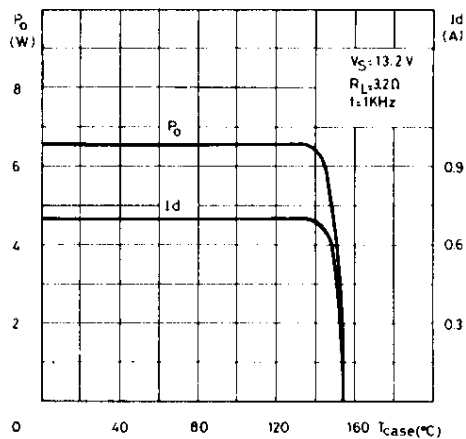
**Figure 18 :** Maximum Allowable Power Dissipation versus Ambient Temperature



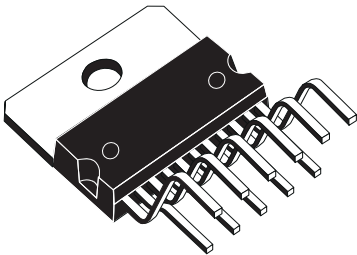
**Figure 19 :** Output Power versus Case Temperature



**Figure 20 :** Output Power and Drain Current versus Case Temperature



DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			5			0.197
B			2.65			0.104
C			1.6			0.063
D		1			0.039	
E	0.49		0.55	0.019		0.022
F	0.88		0.95	0.035		0.037
G	1.45	1.7	1.95	0.057	0.067	0.077
G1	16.75	17	17.25	0.659	0.669	0.679
H1	19.6			0.772		
H2			20.2			0.795
L	21.9	22.2	22.5	0.862	0.874	0.886
L1	21.7	22.1	22.5	0.854	0.87	0.886
L2	17.4		18.1	0.685		0.713
L3	17.25	17.5	17.75	0.679	0.689	0.699
L4	10.3	10.7	10.9	0.406	0.421	0.429
L7	2.65		2.9	0.104		0.114
M	4.25	4.55	4.85	0.167	0.179	0.191
M1	4.73	5.08	5.43	0.186	0.200	0.214
S	1.9		2.6	0.075		0.102
S1	1.9		2.6	0.075		0.102
Dia1	3.65		3.85	0.144		0.152



Multiwatt11 V

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